

TIP47, TIP48, TIP50

Preferred Device

High Voltage NPN Silicon Power Transistors

This series is designed for line operated audio output amplifier, SWITCHMODE™ power supply drivers and other switching applications.

Features

- 250 V to 400 V (Min) – $V_{CEO(sus)}$
- 1 A Rated Collector Current
- Popular TO–220 Plastic Package
- Pb–Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	TIP47	TIP48	TIP50	Unit
Collector – Emitter Voltage	V_{CEO}	250	300	400	Vdc
Collector – Base Voltage	V_{CB}	350	400	500	Vdc
Emitter – Base Voltage	V_{EB}	5.0			Vdc
Collector Current	I_C				Adc
– Continuous		1.0			
– Peak		2.0			
Base Current	I_B	0.6			Adc
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	40			W
		0.32			W/ $^\circ\text{C}$
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	2.0			W
		0.016			W/ $^\circ\text{C}$
Unclamped Inducting Load Energy (See Figure 8)	E	20			mJ
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to +150			$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction–to–Case	$R_{\theta JC}$	3.125	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction–to–Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$

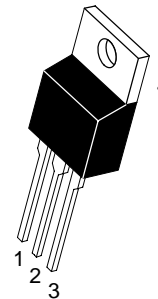
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

**1.0 AMPERE
POWER TRANSISTORS
NPN SILICON
250–300–350–400 VOLTS
40 WATTS**



TO–220AB
CASE 221A
STYLE 1

MARKING DIAGRAM



TIPxx = Device Code
xx = 47, 48, or 50
A = Assembly Location
Y = Year
WW = Work Week
G = Pb–Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

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ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (Note 1) ($I_C = 30\text{ mAdc}$, $I_B = 0$)	TIP47 TIP48 TIP50	$V_{CEO(sus)}$	250 300 400	– – – Vdc
Collector Cutoff Current ($V_{CE} = 150\text{ Vdc}$, $I_B = 0$) ($V_{CE} = 200\text{ Vdc}$, $I_B = 0$) ($V_{CE} = 300\text{ Vdc}$, $I_B = 0$)	TIP47 TIP48 TIP50	I_{CEO}	– – –	1.0 1.0 1.0 mAdc
Collector Cutoff Current ($V_{CE} = 350\text{ Vdc}$, $V_{BE} = 0$) ($V_{CE} = 400\text{ Vdc}$, $V_{BE} = 0$) ($V_{CE} = 500\text{ Vdc}$, $V_{BE} = 0$)	TIP47 TIP48 TIP50	I_{CES}	– – –	1.0 1.0 1.0 mAdc
Emitter Cutoff Current ($V_{BE} = 5.0\text{ Vdc}$, $I_C = 0$)		I_{EBO}	–	1.0 mAdc

ON CHARACTERISTICS (Note 1)

DC Current Gain ($I_C = 0.3\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$) ($I_C = 1.0\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$)	h_{FE}	30 10	150 –	–
Collector–Emitter Saturation Voltage ($I_C = 1.0\text{ Adc}$, $I_B = 0.2\text{ Adc}$)	$V_{CE(sat)}$	–	1.0	Vdc
Base–Emitter On Voltage ($I_C = 1.0\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$)	$V_{BE(on)}$	–	1.5	Vdc

DYNAMIC CHARACTERISTICS

Current–Gain – Bandwidth Product ($I_C = 0.1\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$, $f = 2.0\text{ MHz}$)	f_T	10	–	MHz
Small–Signal Current Gain ($I_C = 0.2\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$, $f = 1.0\text{ kHz}$)	h_{fe}	25	–	–

1. Pulse Test: Pulse width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

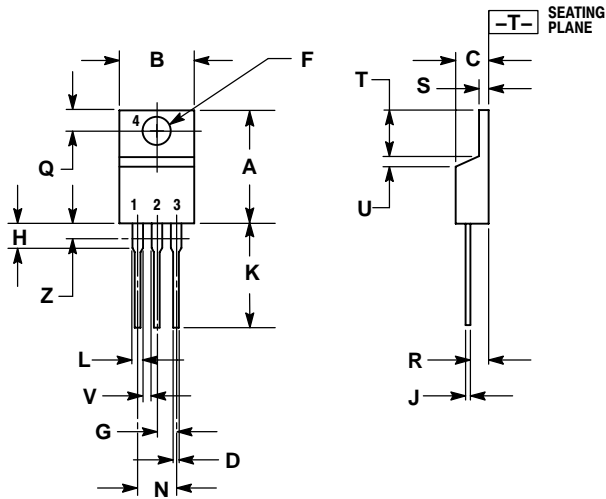
ORDERING INFORMATION

Device	Package	Shipping
TIP47	TO–220	50 Units / Rail
TIP47G	TO–220 (Pb–Free)	50 Units / Rail
TIP48	TO–220	50 Units / Rail
TIP48G	TO–220 (Pb–Free)	50 Units / Rail
TIP49	TO–220	50 Units / Rail
TIP49G	TO–220 (Pb–Free)	50 Units / Rail
TIP50	TO–220	50 Units / Rail
TIP50G	TO–220 (Pb–Free)	50 Units / Rail

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PACKAGE DIMENSIONS

TO-220
CASE 221A-09
ISSUE AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 1:

- PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR